

## 14 + 1 channel buffers for TFT-LCD panels

Datasheet – production data

### Features

- Wide supply voltage: 5.5 V to 16.8 V
- Low operating current: 6 mA typical at 25 °C
- Gain bandwidth product: 1 MHz
- High current COM amplifier:  $\pm 100$  mA output current
- Industrial temperature range: -40 °C to +85 °C
- Small package: TQFP48
- Automotive qualification

### Application

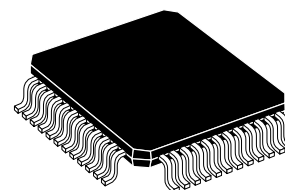
- TFT liquid crystal display (LCD)

### Description

The TSL1014 device is composed of 14 + 1 channel buffers which are used to buffer the reference voltage for gamma correction in thin film transistor (TFT) liquid crystal displays (LCD).

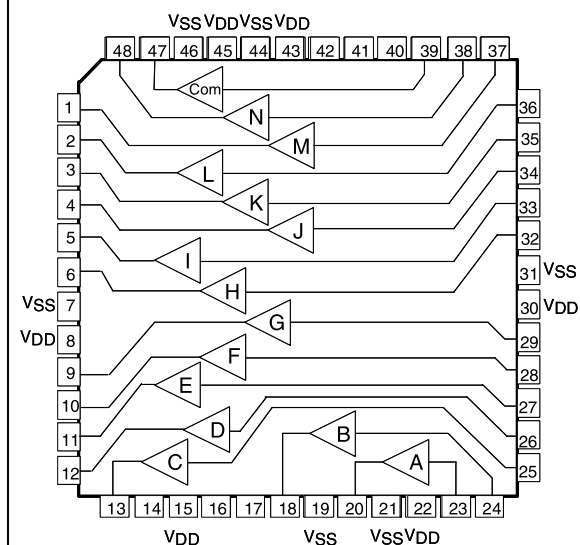
One “COM” amplifier is able to deliver high output current value, up to  $\pm 100$  mA. Amplifiers A and B feature positive single supply inputs for common mode voltage behavior. The amplifiers C to N inclusive, and the COM amplifier, feature negative single supply inputs and are dedicated to the highest and lowest gamma voltages.

The TSL1014 device is fully characterized and guaranteed over a wide industrial temperature range (-40 to +85 °C).



7 x 7 mm TQFP48

#### Pin connections (top view)



# 1 Absolute maximum ratings and operating conditions

**Table 1. Absolute maximum ratings**

| Symbol            | Parameter  | Value  | Unit |
|-------------------|--|--|------|
| V <sub>CC</sub>   | Supply voltage (V <sub>DD</sub> - V <sub>SS</sub> )                          | 18   | V    |
| V <sub>IN</sub>   | Input voltage  | V <sub>SS</sub> -0.5 V to V <sub>DD</sub> +0.5 V | V    |
| I <sub>OUT</sub>  | Output current (A to N buffers)<br>Output current (COM buffer)               | 30<br>100  | mA   |
| I <sub>SC</sub>   | Short-circuit current (A to N buffers)<br>Short-circuit current (COM buffer) | ±120<br>±300                                     | mA   |
| P <sub>D</sub>    | Power dissipation <sup>(1)</sup> for TQFP48                                  | 1470   | mW   |
| R <sub>THJA</sub> | Thermal resistance junction-to-ambient for TQFP48                            | 85   | °C/W |
| T <sub>LEAD</sub> | Lead temperature (soldering 10 seconds)                                      | 260  | °C   |
| T <sub>STG</sub>  | Storage temperature  | -65 to +150                                      | °C   |
| T <sub>J</sub>    | Junction temperature   | 150  | °C   |
| ESD               | Human body model (HBM) <sup>(2)</sup>  | 2000   | V    |
|                   | Machine model (MM) <sup>(3)</sup>  | 200  |      |
|                   | Charged device model (CDM) <sup>(4)</sup>                                    | 1500   |      |

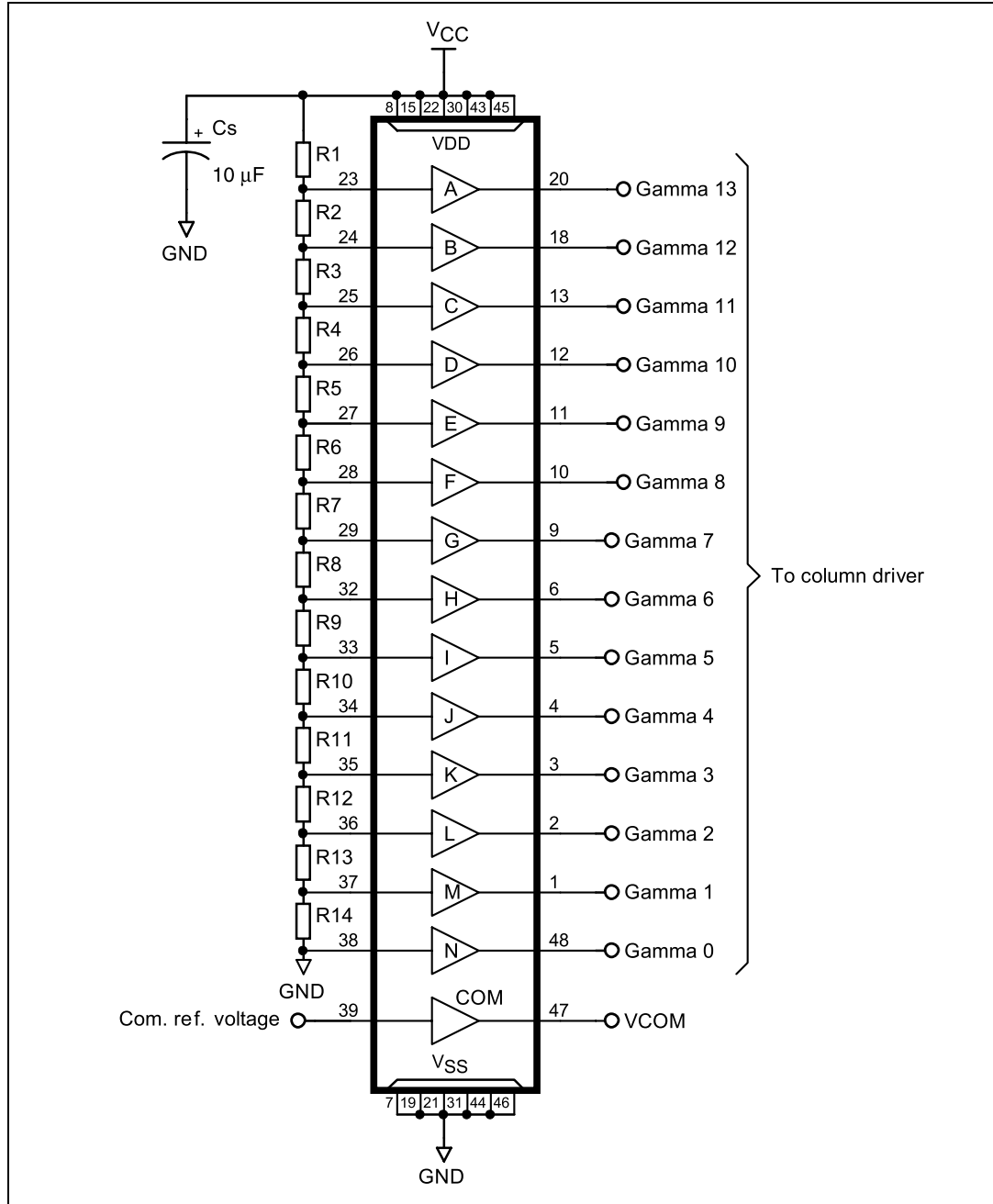
1. P<sub>D</sub> is calculated with T<sub>amb</sub> = 25 °C, T<sub>J</sub> = 150 °C and R<sub>THJA</sub> = 85 °C/W for the TQFP48 package.
2. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 kW resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
3. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 W). This is done for all couples of connected pin combinations while the other pins are floating.
4. Charged device model: all pins and package are charged together to the specified voltage and then discharged directly to ground through only one pin.

**Table 2. Operating conditions**

| Symbol           | Parameter   | Value                                     | Unit |
|------------------|---|---|------|
| V <sub>CC</sub>  | Supply voltage (V <sub>DD</sub> - V <sub>SS</sub> ) | 5.5 to 16.8                               | V    |
| T <sub>amb</sub> | Ambient temperature                                 | -40 to +85                                | °C   |
| V <sub>IN</sub>  | Input voltage (buffers A and B)                     | V <sub>SS</sub> +1.5 V to V <sub>DD</sub> | V    |
|                  | Input voltage (buffers C to N + COM)                | V <sub>SS</sub> to V <sub>DD</sub> -1.5 V |      |

## 2 Typical application schematics

Figure 1. Typical application schematic for the TSL1014 device



Note that:

- Amplifiers **A** and **B** have their input voltage in the range  $V_{SS} + 1.5\text{ V}$  to  $V_{DD}$ . This is why they must be used for high level gamma correction voltages.
- Amplifiers **C** to **N** have their input voltage in the range  $V_{SS}$  to  $V_{DD} - 1.5\text{ V}$ . This is why they must be used for medium-to-low level gamma correction voltages.
- Amplifier **COM** has its input voltage range from  $V_{SS}$  to  $V_{DD} - 1.5\text{ V}$ .

### 3 Electrical characteristics

**Table 3. Electrical characteristics for TSL1014IF/TSL1014IFT**  
 $T_{amb} = 25\text{ °C}$ ,  $V_{DD} = +5\text{ V}$ ,  $V_{SS} = -5\text{ V}$ ,  $R_L = 10\text{ k}\Omega$ ,  $C_L = 10\text{ pF}$   
 (unless otherwise specified)

| Symbol          | Parameter                              | Test conditions   | Min. | Typ.           | Max.           | Unit                    |
|-----------------|--|---|------|----------------|----------------|-------------------------|
| $V_{IO}$        | Input offset voltage                   | $V_{ICM} = 0\text{ V}$  |      |                | 12             | mV                      |
| $\Delta V_{IO}$ | Input offset voltage drift             | $T_{Min} < T_{amb} < T_{Max}$   |      | 5              |                | $\mu\text{V}/\text{°C}$ |
| $I_{IB}$        | Input bias current                     | $V_{ICM} = 0\text{ V}$ , buffers A and B<br>$V_{ICM} = 0\text{ V}$ , buffers C to N and COM |      |                | 140<br>70      | nA                      |
| $R_{IN}$        | Input impedance                        |   |      | 1              |                | G $\Omega$              |
| $C_{IN}$        | Input capacitance                      |   |      | 1.35           |                | pF                      |
| $V_{OL}$        | Output voltage low                     | $I_{OUT} = -5\text{ mA}$<br>Buffers C to L<br>Buffers M, N and COM                          |      | -4.85<br>-4.92 | -4.80<br>-4.85 | V                       |
| $V_{OH}$        | Output voltage high                    | $I_{OUT} = 5\text{ mA}$ for positive single supply buffers (A and B)                        | 4.82 | 4.87           |                | V                       |
| $I_{OUT}$       | Output current                         | (A to N buffers)  |      | $\pm 30$       |                | mA                      |
|                 |  | COM buffer  |      | $\pm 100$      |                |                         |
| PSRR            | Power supply rejection ratio           | $V_{CC} = 6.5\text{ to }15.5\text{ V}$  | 80   | 100            |                | dB                      |
| $I_{CC}$        | Supply current                         | No load   |      | 6              | 8.4            | mA                      |
| SR              | Slew rate<br>(rising and falling edge) | $-4\text{ V} < V_{OUT} < +4\text{ V}$<br>20% to 80%   |      | 1              |                | V/ $\mu\text{s}$        |
| $t_s$           | Settling time                          | Settling to 0.1%, $V_{OUT} = 2\text{ V}$ step   |      | 5              |                | $\mu\text{s}$           |
| BW              | Bandwidth at -3 dB                     | $R_L = 10\text{ k}\Omega$ , $C_L = 10\text{ pF}$  |      | 2              |                | MHz                     |
| $G_m$           | Phase margin                           | $R_L = 10\text{ k}\Omega$ , $C_L = 10\text{ pF}$  |      | 60             |                | Degrees                 |
| $C_s$           | Channel separation                     | $f = 1\text{ MHz}$  |      | 75             |                | dB                      |

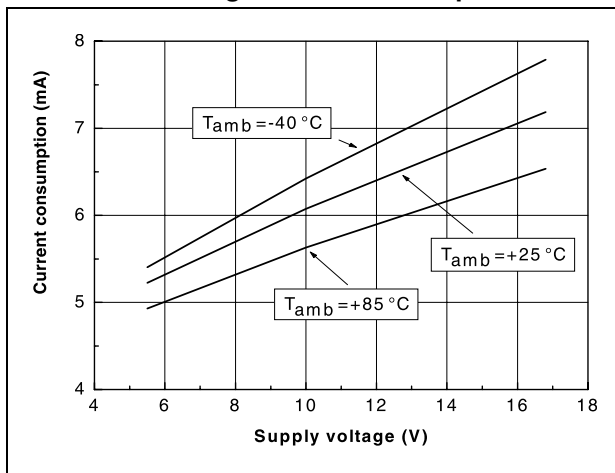
*Note: Limits are 100% production tested at 25 °C. Behavior at the temperature range limits is guaranteed through correlation and by design.*

**Table 4. Electrical characteristics for TSL1014IYFT (automotive grade)**  
 $T_{amb} = 25\text{ °C}$ ,  $V_{DD} = +5\text{ V}$ ,  $V_{SS} = -5\text{ V}$ ,  $R_L = 10\text{ k}\Omega$ ,  $C_L = 10\text{ pF}$   
 (unless otherwise specified)

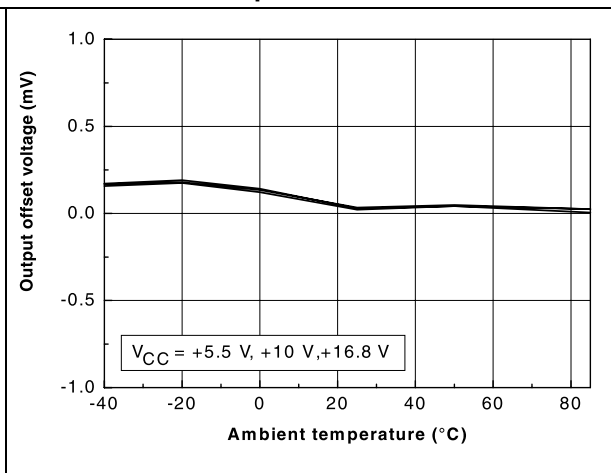
| Symbol          | Parameter                              | Test conditions   | Min.         | Typ.                  | Max.                                 | Unit                    |
|-----------------|--|---|--------------|-----------------------|--------------------------------------|-------------------------|
| $V_{IO}$        | Input offset voltage                   | $V_{ICM} = 0\text{ V}$<br>$T_{Min} < T_{amb} < T_{Max}$   |              |                       | 12                                   | mV                      |
| $\Delta V_{IO}$ | Input offset voltage drift             | $T_{Min} < T_{amb} < T_{Max}$   |              | 5                     |                                      | $\mu\text{V}/\text{°C}$ |
| $I_{IB}$        | Input bias current                     | $V_{ICM} = 0\text{ V}$ , buffers A and B<br>$T_{Min} < T_{amb} < T_{Max}$<br><br>$V_{ICM} = 0\text{ V}$ , buffers C to N and COM<br>$T_{Min} < T_{amb} < T_{Max}$ |              |                       | 140<br>280<br><br>70<br>140          | nA                      |
| $R_{IN}$        | Input impedance                        |   |              | 1                     |                                      | $\text{G}\Omega$        |
| $C_{IN}$        | Input capacitance                      |   |              | 1.35                  |                                      | pF                      |
| $V_{OL}$        | Output voltage low                     | $I_{OUT} = -5\text{ mA}$<br>Buffers C to L<br>$T_{Min} < T_{amb} < T_{Max}$<br><br>Buffers M, N and COM<br>$T_{Min} < T_{amb} < T_{Max}$                          |              | -4.85<br><br>-4.92    | -4.80<br>-4.76<br><br>-4.85<br>-4.83 | V                       |
| $V_{OH}$        | Output voltage high                    | $I_{OUT} = 5\text{ mA}$ for positive single-supply buffers (A and B)<br>$T_{Min} < T_{amb} < T_{Max}$   | 4.82<br>4.80 | 4.87                  |                                      | V                       |
| $I_{OUT}$       | Output current                         | (A to N buffers)<br>COM buffer  |              | $\pm 30$<br>$\pm 100$ |                                      | mA                      |
| PSRR            | Power supply rejection ratio           | $V_{CC} = 6.5\text{ to }15.5\text{ V}$<br>$T_{Min} < T_{amb} < T_{Max}$   | 80           | 100                   |                                      | dB                      |
| $I_{CC}$        | Supply current                         | No load<br>$T_{Min} < T_{amb} < T_{Max}$  |              | 6                     | 8.4<br>9                             | mA                      |
| SR              | Slew rate<br>(rising and falling edge) | $-4\text{ V} < V_{OUT} < +4\text{ V}$<br>20% to 80%   |              | 1                     |                                      | $\text{V}/\mu\text{s}$  |
| $t_s$           | Settling time                          | Settling to 0.1%, $V_{OUT} = 2\text{ V}$ step   |              | 5                     |                                      | $\mu\text{s}$           |
| BW              | Bandwidth at -3 dB                     | $R_L = 10\text{ k}\Omega$ , $C_L = 10\text{ pF}$  |              | 2                     |                                      | MHz                     |
| $G_m$           | Phase margin                           | $R_L = 10\text{ k}\Omega$ , $C_L = 10\text{ pF}$  |              | 60                    |                                      | Degrees                 |
| $C_s$           | Channel separation                     | $f = 1\text{ MHz}$  |              | 75                    |                                      | dB                      |

*Note: Limits are 100% production tested at 25 °C. Behavior at the temperature range limits is guaranteed through correlation and by design.*

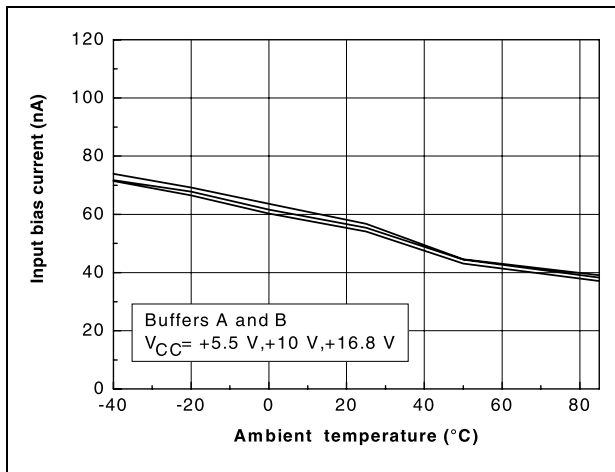
**Figure 2. Supply current vs. supply voltage for various temperatures**



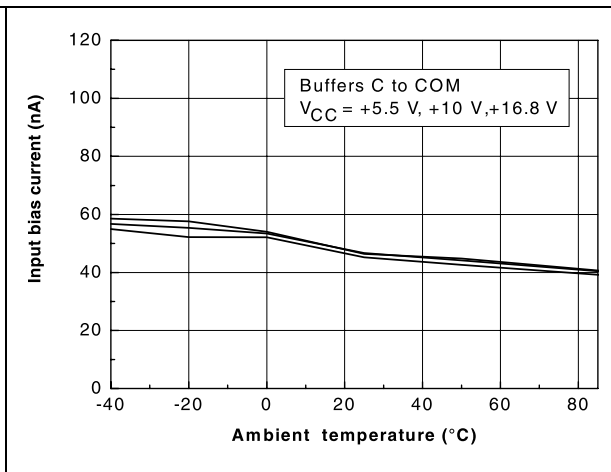
**Figure 3. Output offset voltage (eq.  $V_{IO}$ ) vs. temperature**



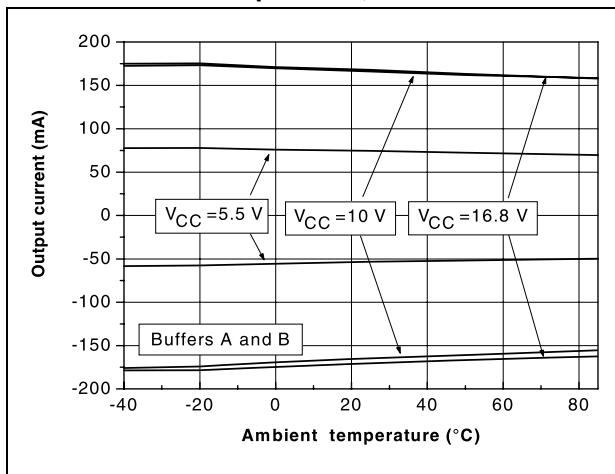
**Figure 4. Input current ( $I_{IB}$ ) vs. temperature, buffers A and B**



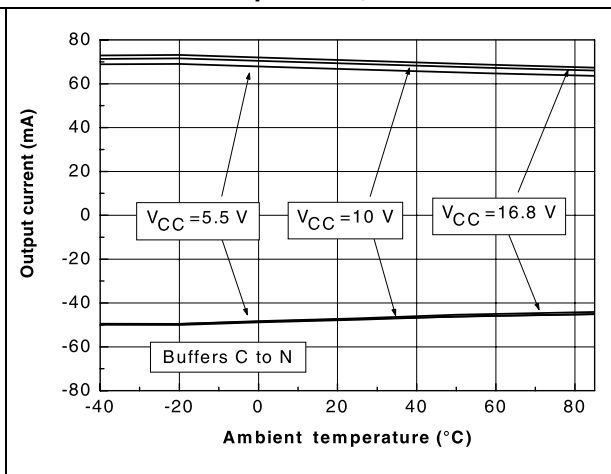
**Figure 5. Input current ( $I_{IB}$ ) vs. temperature, buffers C to COM**



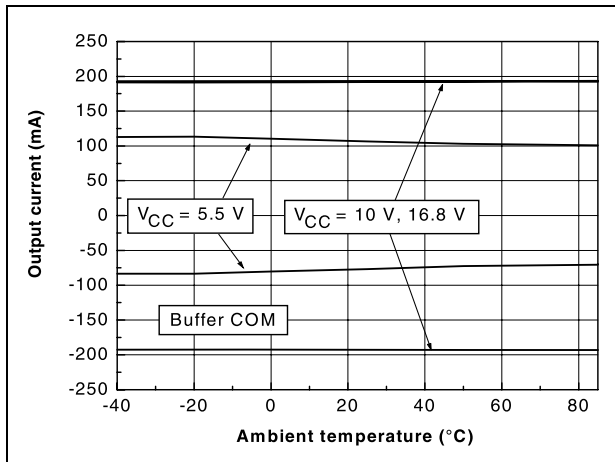
**Figure 6. Output current capability vs. temperature, buffers A and B**



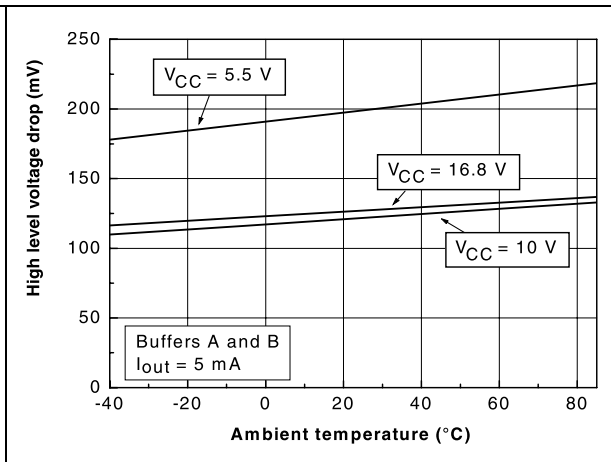
**Figure 7. Output current capability vs. temperature, buffers C to N**



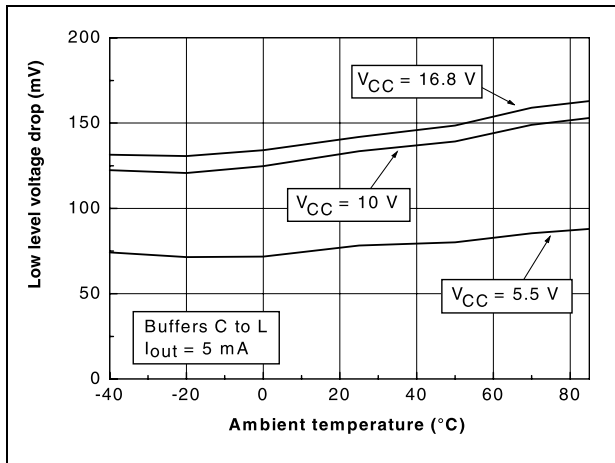
**Figure 8. Output current capability vs. temperature, buffer COM**



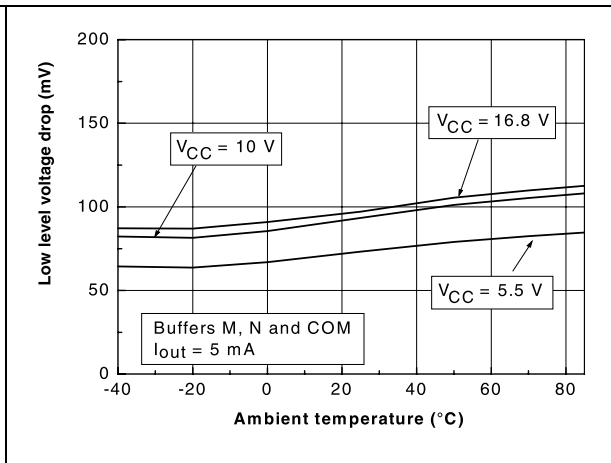
**Figure 9. High level voltage drop vs. temperature**



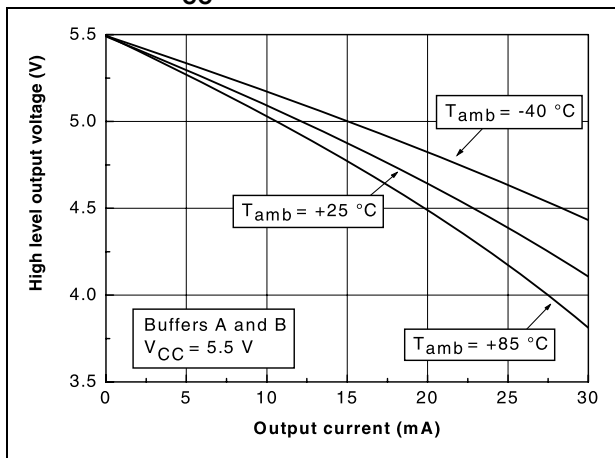
**Figure 10. Low level voltage drop vs. temperature, buffers C to L**



**Figure 11. Low level voltage drop vs. temperature, buffers M, N, and COM**



**Figure 12. Voltage output high (VOH) vs. output current - buffers A and B, VCC = 5 V**



**Figure 13. Voltage output high (VOH) vs. output current - buffers A and B, VCC = 10 V**

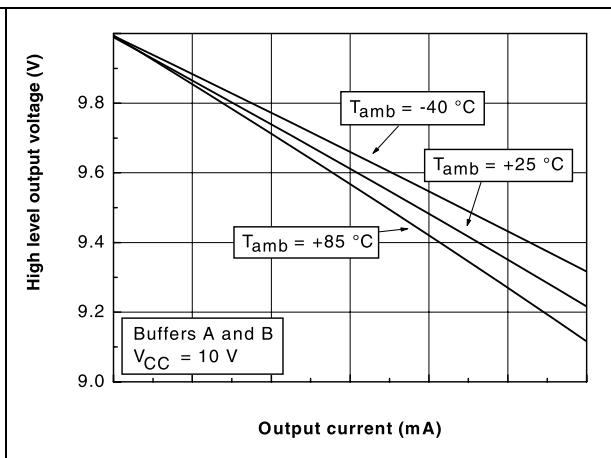


Figure 14. Voltage output high ( $V_{OH}$ ) vs. output current - buffers A and B,  $V_{CC} = 16.8$  V

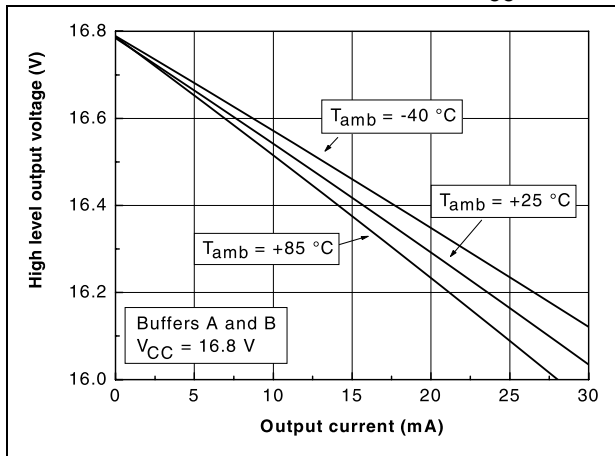


Figure 15. Voltage output low ( $V_{OL}$ ) vs. output current - buffers C to L,  $V_{CC} = 5.5$  V

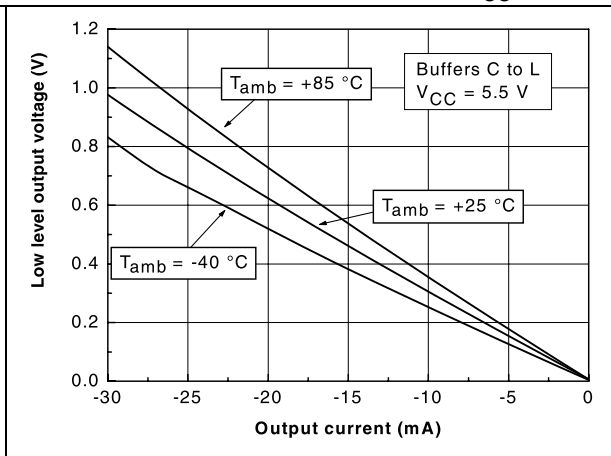


Figure 16. Voltage output low ( $V_{OL}$ ) vs. output current - buffers C to L,  $V_{CC} = 10$  V

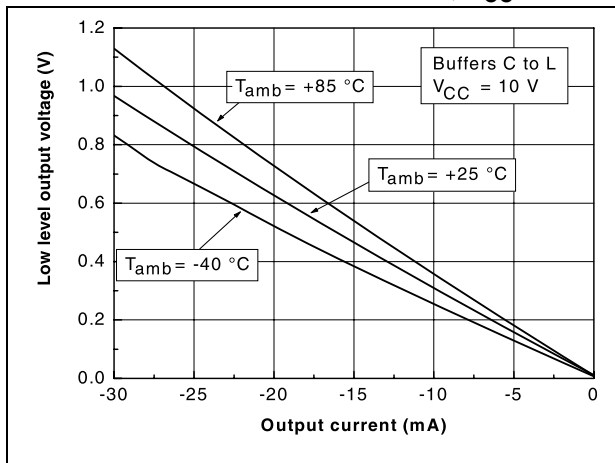


Figure 17. Voltage output low ( $V_{OL}$ ) vs. output current - buffers C to L,  $V_{CC} = 16.8$  V

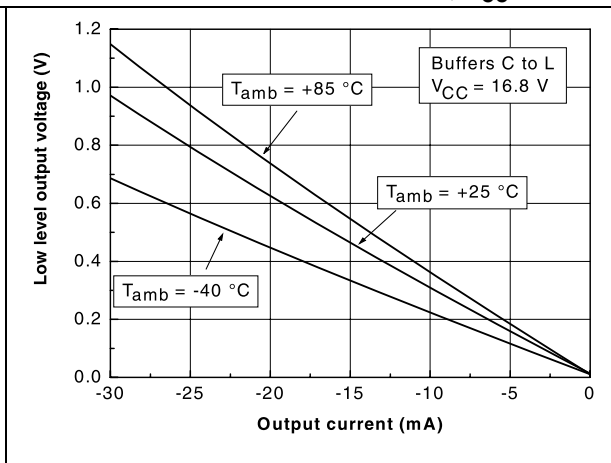


Figure 18. Voltage output low ( $V_{OL}$ ) vs. output current - buffers M, N and COM,  $V_{CC} = 5.5$  V

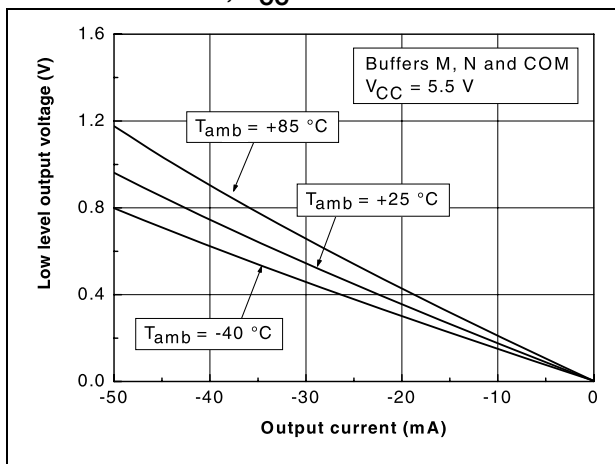
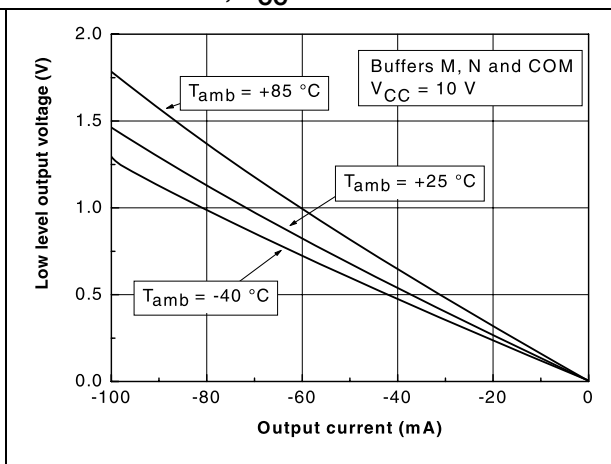
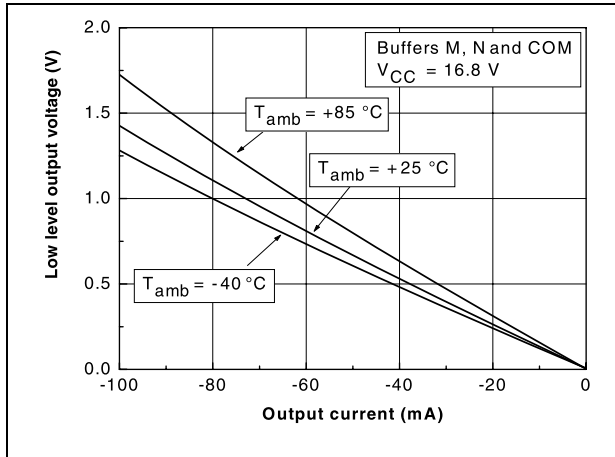


Figure 19. Voltage output low ( $V_{OL}$ ) vs. output current - buffers M, N and COM,  $V_{CC} = 10$  V

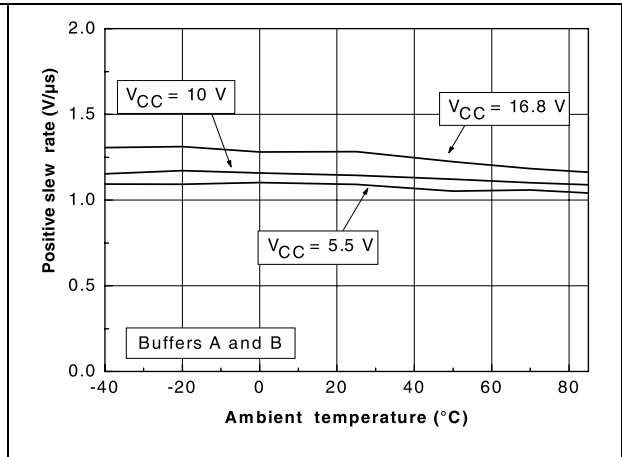




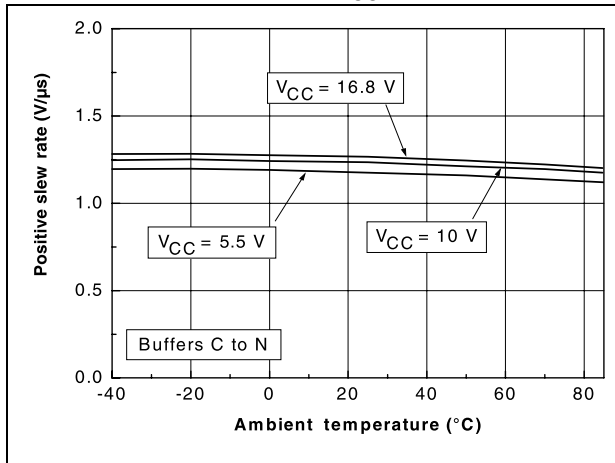
**Figure 20. Voltage output low ( $V_{OL}$ ) vs. output current - buffers M, N and COM,  $V_{CC} = 16.8\text{ V}$**



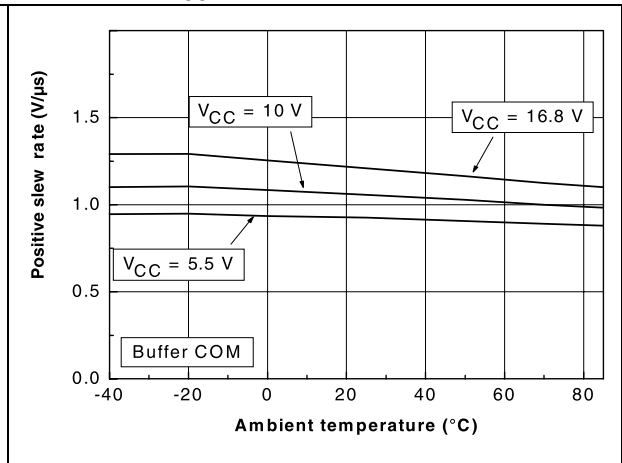
**Figure 21. Positive slew rate vs. temperature,  $V_{CC} = 5.5\text{ V}$**



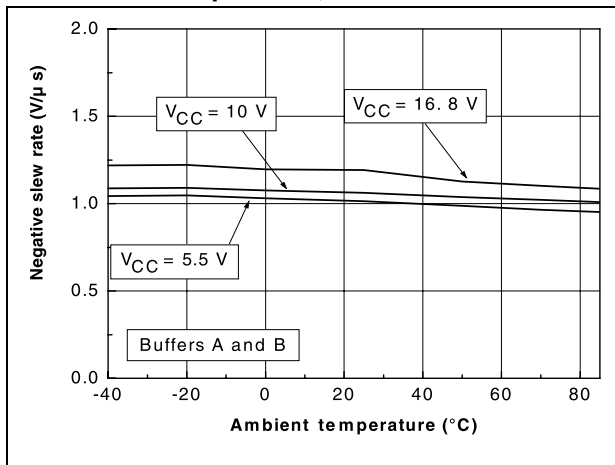
**Figure 22. Positive slew rate vs. temperature,  $V_{CC} = 10\text{ V}$**



**Figure 23. Positive slew rate vs. temperature,  $V_{CC} = 16.8\text{ V}$**



**Figure 24. Negative slew rate vs. temperature, buffers A and B**



**Figure 25. Negative slew rate vs. temperature, buffers C to N**

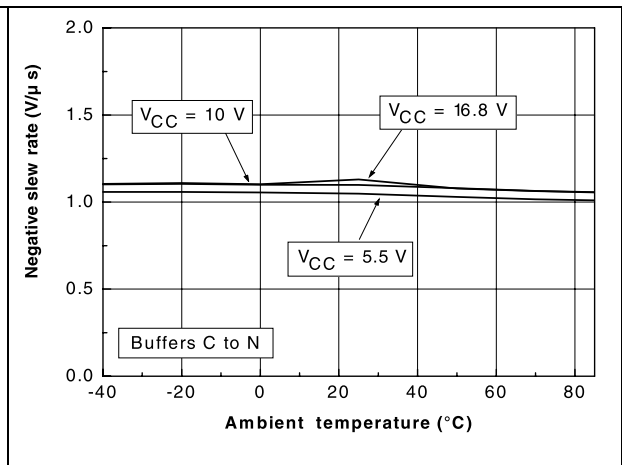


Figure 26. Negative slew rate vs. temperature, buffer COM

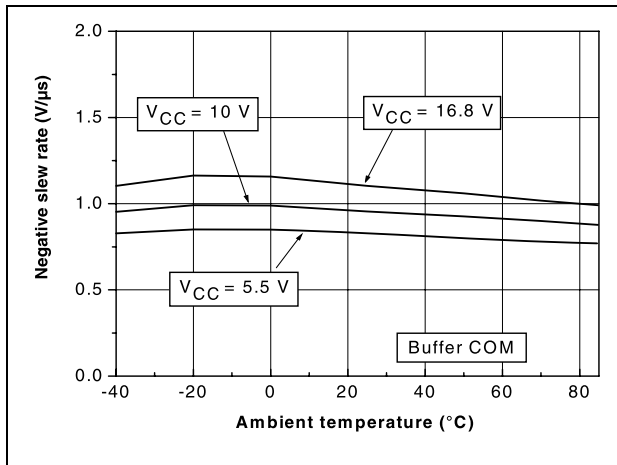


Figure 27. Large signal response - buffers A and B - positive step

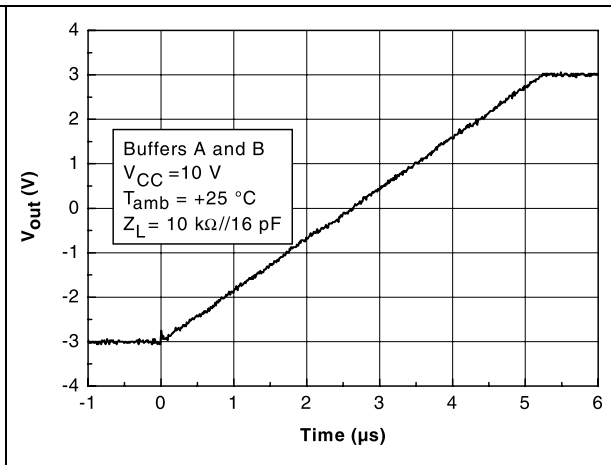


Figure 28. Large signal response - buffers A and B - negative step

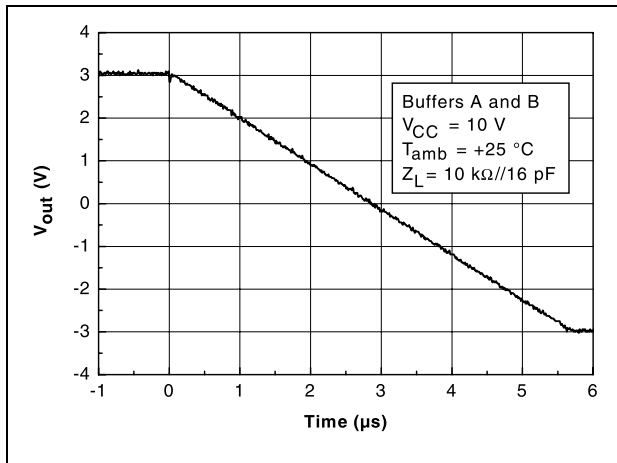


Figure 29. Large signal response - buffers C to N - positive step

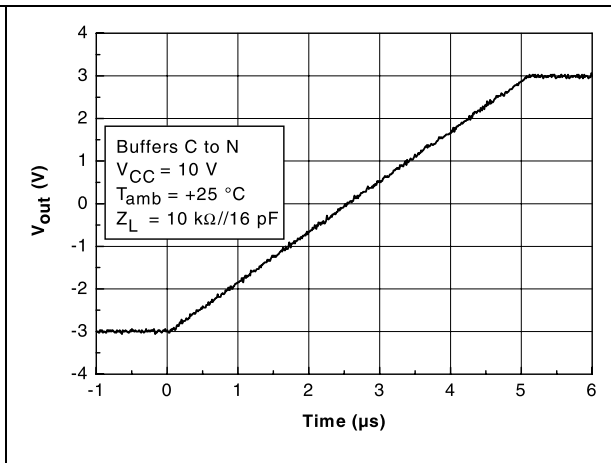


Figure 30. Large signal response - buffers C to N - negative step

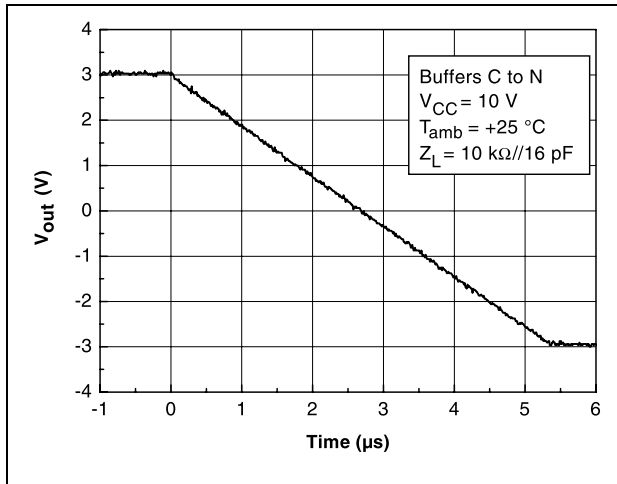
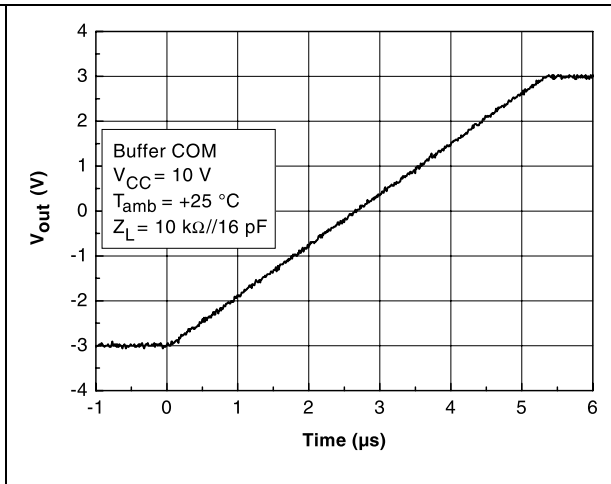
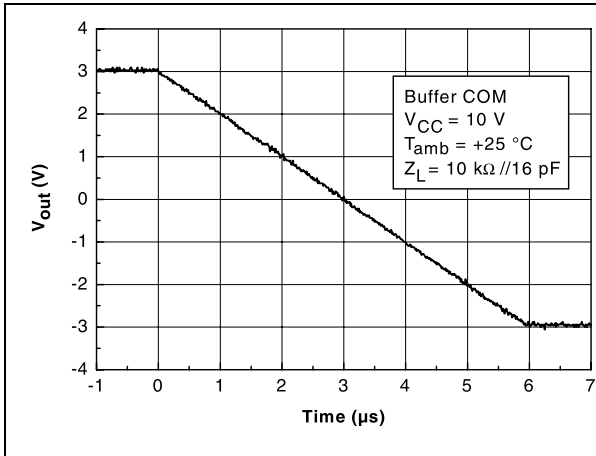


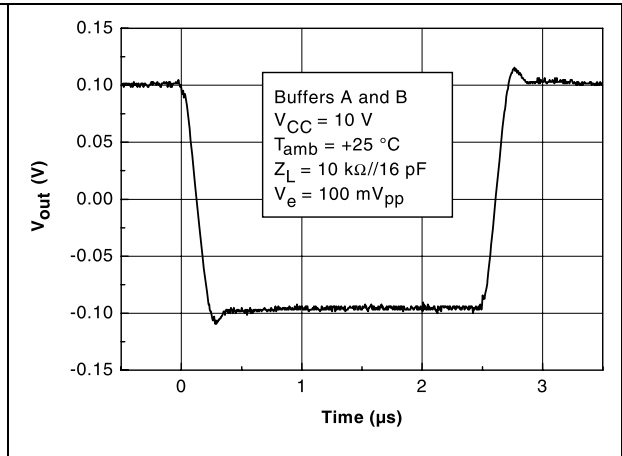
Figure 31. Large signal response - buffer COM - positive step



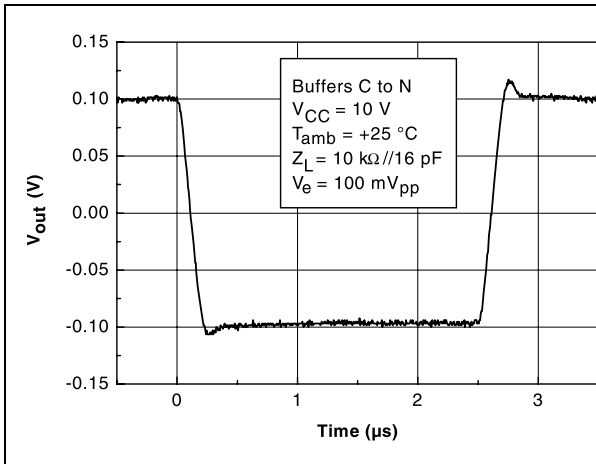
**Figure 32. Large signal response - buffer COM - negative step**



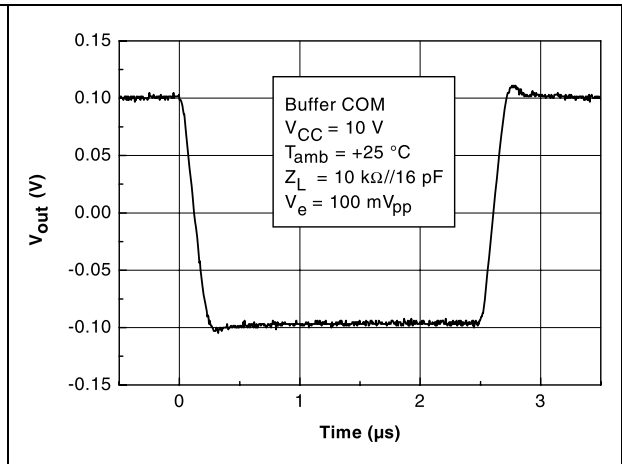
**Figure 33. Small signal response - buffers A and B**



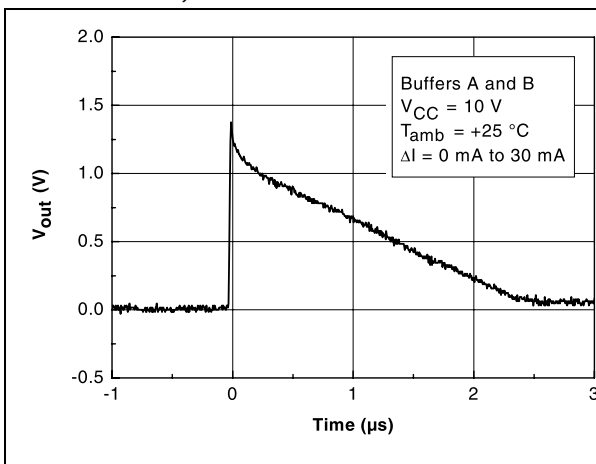
**Figure 34. Small signal response - buffers C to N**



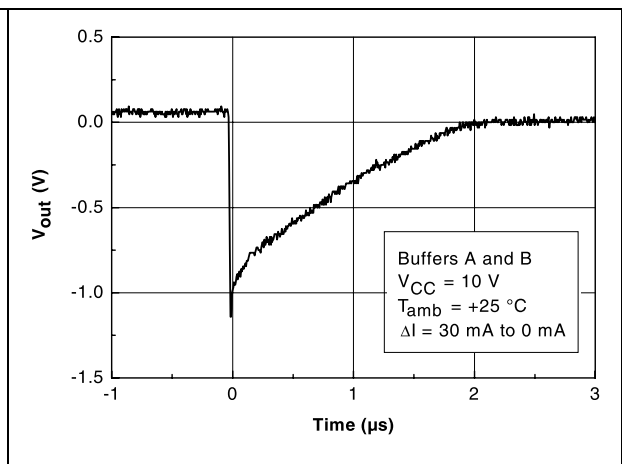
**Figure 35. Small signal response - buffer COM**



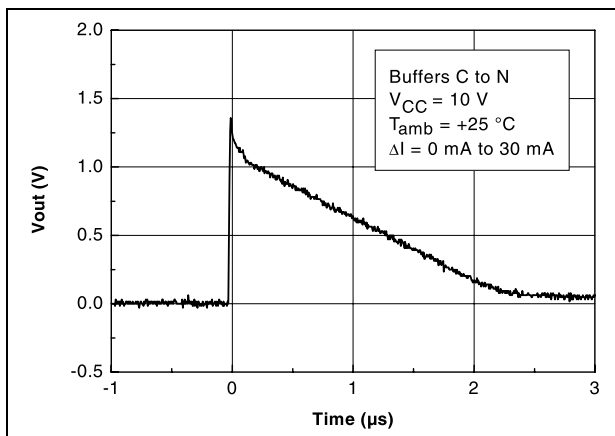
**Figure 36. Output voltage response to current transient - buffers A and B,  $\Delta I = 0$  to 30 mA**



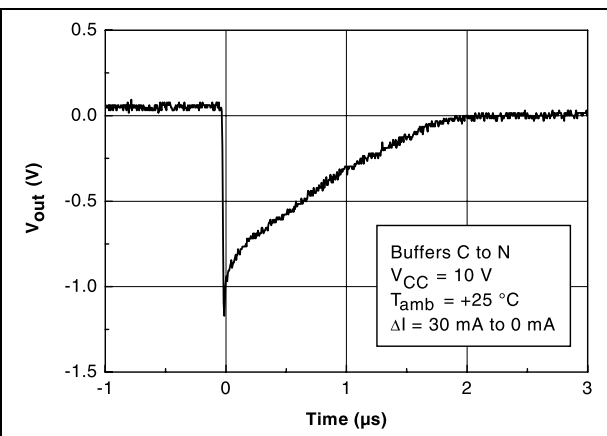
**Figure 37. Output voltage response to current transient - buffers A and B,  $\Delta I = 30$  to 0 mA**



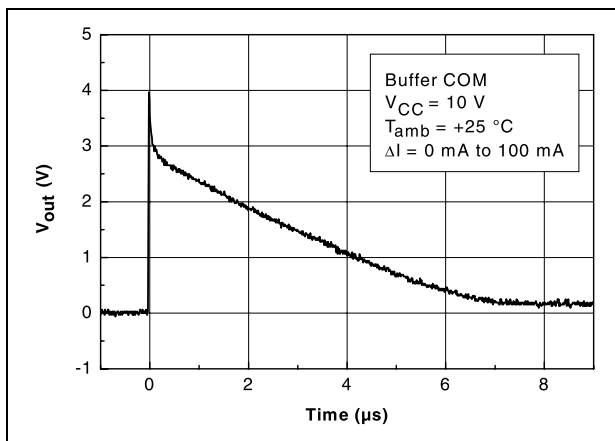
**Figure 38. Output voltage response to current transient - buffers C to N,  $\Delta I = 0$  to 30 mA**



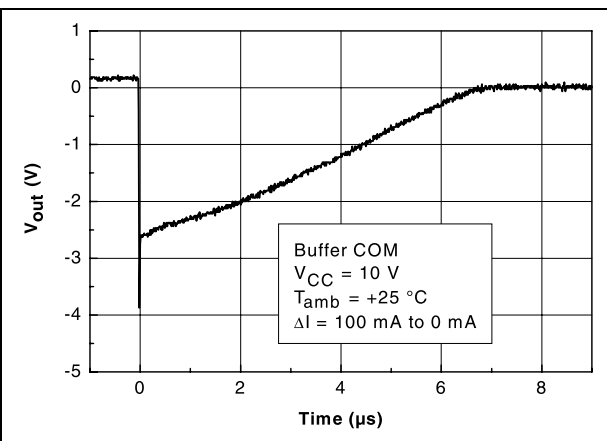
**Figure 39. Output voltage response to current transient - buffers C to N,  $\Delta I = 30$  to 0 mA**



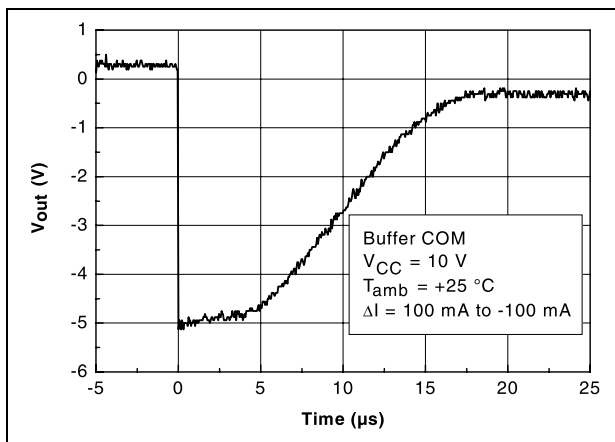
**Figure 40. Output voltage response to current transient - buffer COM,  $\Delta I = 0$  to 100 mA**



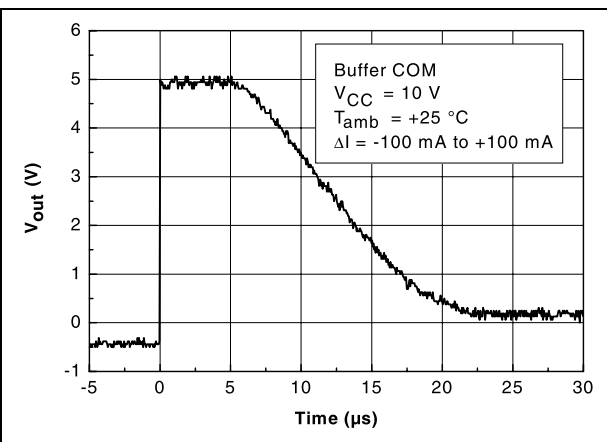
**Figure 41. Output voltage response to current transient - buffer COM,  $\Delta I = 100$  to 0 mA**



**Figure 42. Output voltage response to current transient - buffer COM,  $\Delta I = 100$  to -100 mA**



**Figure 43. Output voltage response to current transient - buffer COM,  $\Delta I = -100$  to +100 mA**



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

Figure 44. TQFP48 package outline

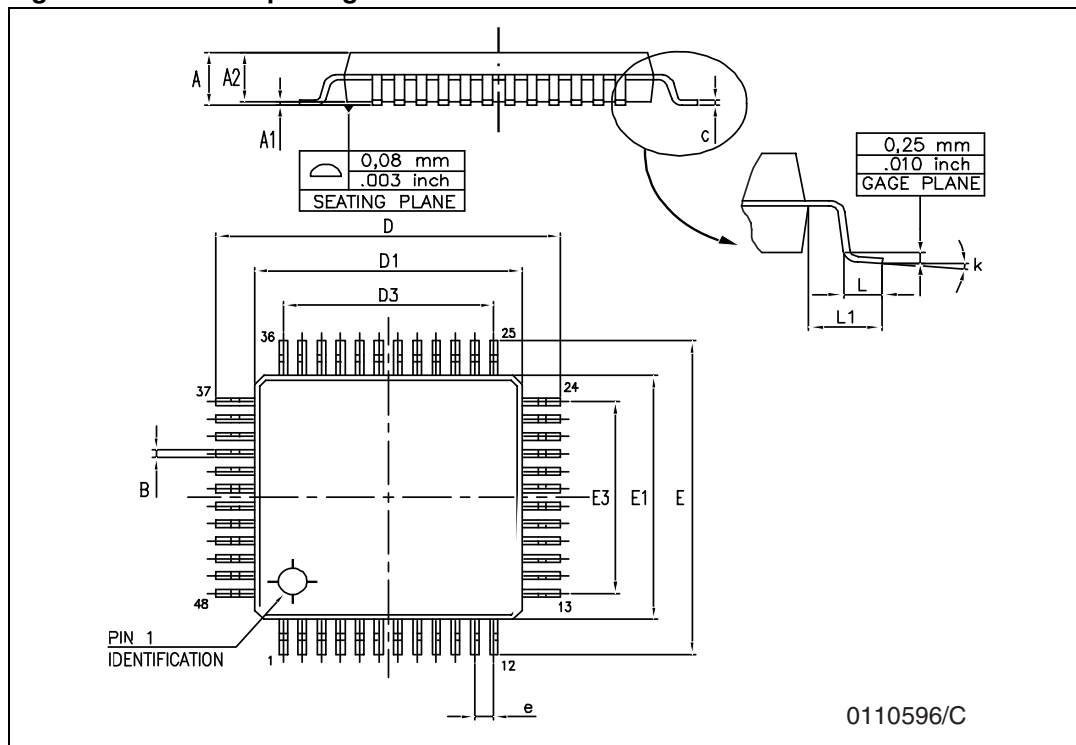


Table 5. TQFP48 package mechanical data

| Symbol | Dimensions  |      |      |        |       |        |
|--------|-------------|------|------|--------|-------|--------|
|        | Millimeters |      |      | Inches |       |        |
|        | Min.        | Typ. | Max. | Min.   | Typ.  | Max.   |
| A      |             |      | 1.6  |        |       | 0.063  |
| A1     | 0.05        |      | 0.15 | 0.002  |       | 0.006  |
| A2     | 1.35        | 1.40 | 1.45 | 0.053  | 0.055 | 0.057  |
| B      | 0.17        | 0.22 | 0.27 | 0.007  | 0.009 | 0.011  |
| C      | 0.09        |      | 0.20 | 0.0035 |       | 0.0079 |
| D      |             | 9.00 |      |        | 0.354 |        |
| D1     |             | 7.00 |      |        | 0.276 |        |
| D3     |             | 5.50 |      |        | 0.216 |        |
| e      |             | 0.50 |      |        | 0.020 |        |
| E      |             | 9.00 |      |        | 0.354 |        |
| E1     |             | 7.00 |      |        | 0.276 |        |
| E3     |             | 5.50 |      |        | 0.216 |        |
| L      | 0.45        | 0.60 | 0.75 | 0.018  | 0.024 | 0.030  |
| L1     |             | 1.00 |      |        | 0.039 |        |
| K      | 0°          | 3.5° | 7°   | 0°     | 3.5°  | 7°     |

## 5 Ordering information

**Table 6. Order codes**

| Order code                 | Temperature range | Package | Packing       | Marking |
|----------------------------|-------------------|---------|---------------|---------|
| TSL1014IF                  | -40 °C to +85 °C  | TQFP48  | Tray          | SL1014I |
| TSL1014IFT                 |                   |         | Tape and reel |         |
| TSL1014IYFT <sup>(1)</sup> |                   |         | Tape and reel | SL1014Y |

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q 002 or equivalent.

## 6 Revision history

**Table 7. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 01-Jul-2005 | 1        | Initial release - Product in full production.   |
| 01-Sep-2005 | 2        | Lead temperature corrected in <a href="#">Table 1 on page 2</a> .<br>Electrical characteristics graphs re-ordered from <a href="#">Figure 2 on page 6</a> to <a href="#">Figure 43 on page 12</a> .   |
| 07-Mar-2007 | 3        | Notes added on ESD in <a href="#">Table 1 on page 2</a> .<br>Maximum operating supply voltage increased in <a href="#">Table 2 on page 2</a> .<br>Input voltage parameters added in <a href="#">Table 2 on page 2</a> .<br>$V_{OL}$ limits changed for Buffers C to L in <a href="#">Table 4 on page 5</a> .  |
| 09-Jun-2008 | 4        | Electrical characteristics table added for automotive parts.<br>Order codes added for automotive parts.   |
| 19-Aug-2008 | 5        | Modified $I_{CC}$ typical and maximum values for standard parts in <a href="#">Table 3</a> .<br>Updated all curves ( <a href="#">Figure 2</a> to <a href="#">Figure 43</a> ).<br>Added ESD charged device model value in <a href="#">Figure 1</a> .   |
| 11-May-2009 | 6        | Modified footnote under <a href="#">Table 6: Order codes</a> .  |
| 14-Nov-2012 | 7        | Removed TSL1014IYF device from <a href="#">Table 4</a> and <a href="#">Table 6</a> .<br>Renamed titles of <a href="#">Figure 4</a> to <a href="#">Figure 8</a> , <a href="#">Figure 10</a> to <a href="#">Figure 32</a> , and <a href="#">Figure 36</a> to <a href="#">Figure 43</a> (added conditions).<br>Reformatted <a href="#">Section 4</a> (added <a href="#">Figure 44</a> ).<br>Minor corrections throughout document. |



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